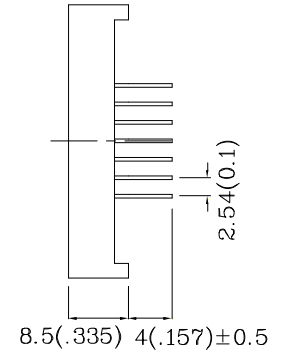
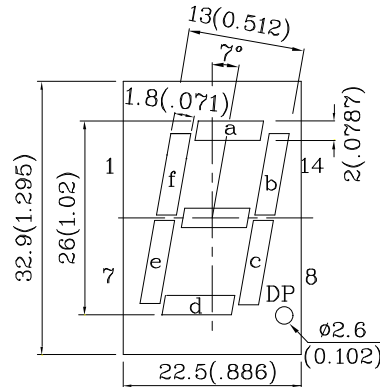
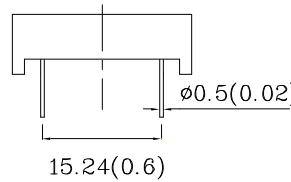
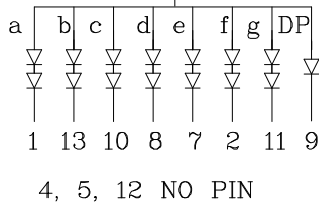


**Features**

- 1.02 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- HIGH LIGHT OUTPUT.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- STANARD : GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.



3 , 6 , 14



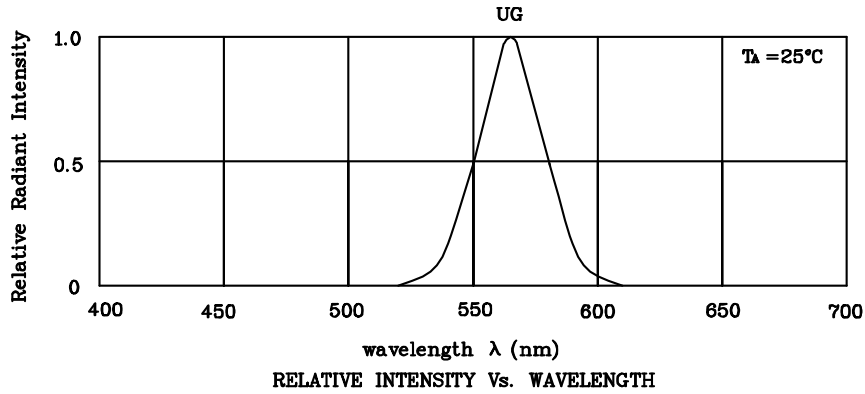
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
3. Specifications are subject to change without notice.

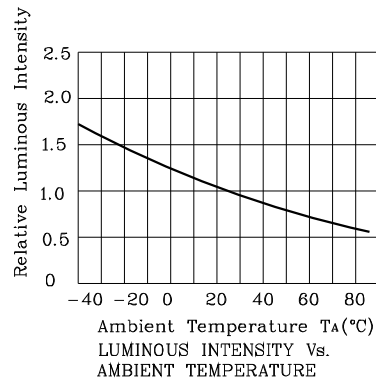
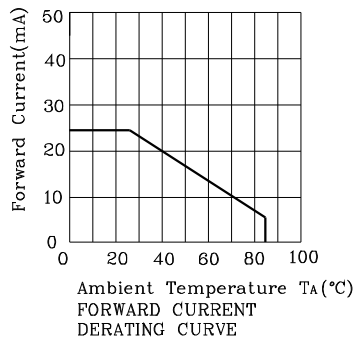
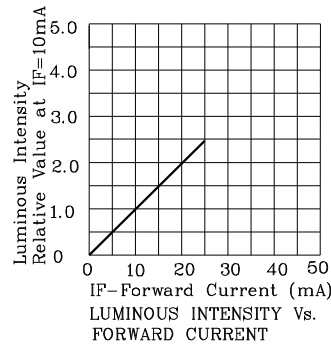
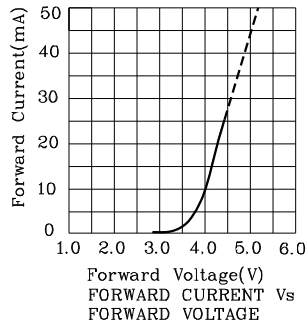
Absolute Maximum Ratings (TA=25°C)		UG (GaP)	Unit
Reverse Voltage Per Segment or (Dp)	V <sub>R</sub>	10(5)	V
Forward Current Per Segment or (Dp)	I <sub>F</sub>	25(25)	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width Per Segment or (Dp)	i <sub>FS</sub>	140(140)	mA
Power Dissipation Per Segment or (Dp)	P <sub>T</sub>	125(62.5)	mW
Operating Temperature	T <sub>A</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds		

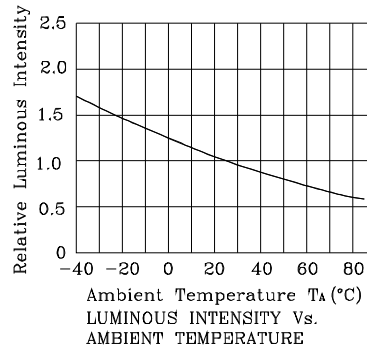
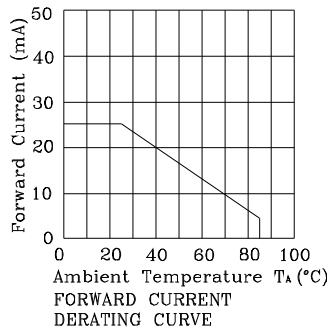
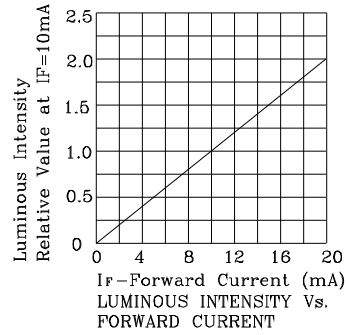
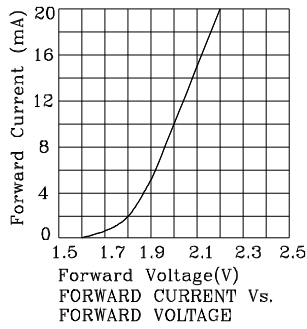
Operating Characteristics (TA=25°C)		UG (GaP)	Unit
Forward Voltage (Typ.) Per Segment Or ( DP) (IF=10mA)	V <sub>F</sub>	4.0(2.0)	V
Forward Voltage (Max.) Per Segment Or ( DP) (IF=10mA)	V <sub>F</sub>	5.0(2.5)	V
Reverse Current Per Segment Or (Dp) (VR=20(10)V)	I <sub>R</sub>	10 (10)	uA
Wavelength Of Peak Emission (Typ.) (IF=10mA)	λ P	565	nm
Wavelength Of Dominant Emission (Typ.) (IF=10mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=10mA)	Δλ	30	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm $\lambda$ P	Description
			min.	typ.		
DUG25A-1	Green	GaP	4700	23990	565	Common Anode, Rt. Hand Decimal

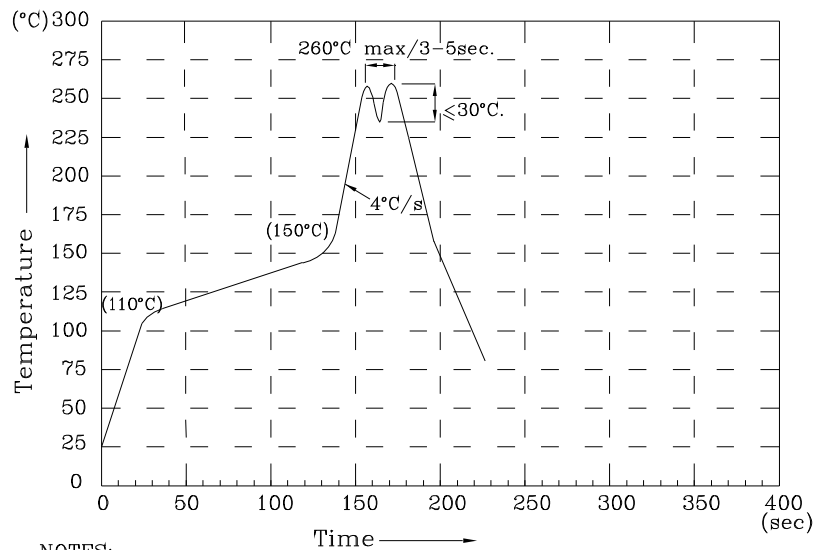


❖ UG





Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

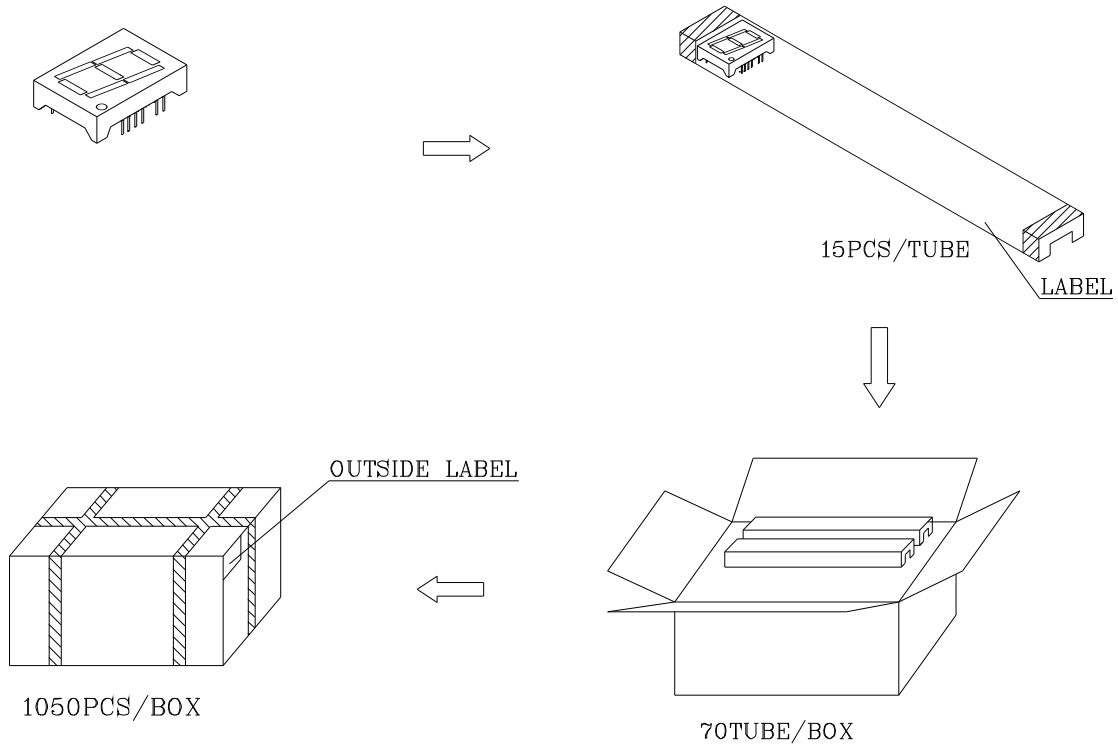
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

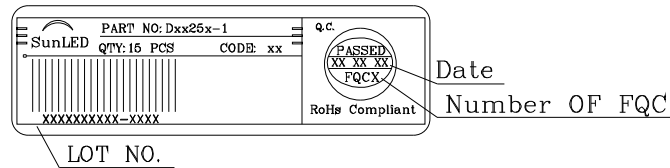
Note: Accuracy may depend on the sorting parameters.

**PACKING & LABEL SPECIFICATIONS**

**DUG25A-1**



Inside LABEL Paste On The IC-tube



Outside LABEL Paste On The Box

